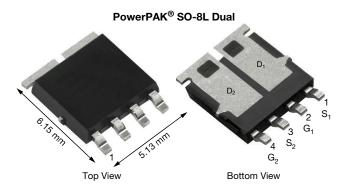
SQJB46ELP

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Vishay Siliconix

Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFET



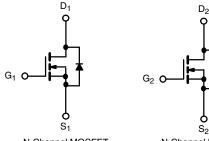
FEATURES

- TrenchFET[®] Gen IV Power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



RoHS COMPLIANT HALOGEN FREE

PRODUCT SUMMARY			
V _{DS} (V)	40		
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.008		
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.010		
I _D (A) per leg	30		
Configuration	Dual		



N-Channel MOSFET

S₂ N-Channel MOSFET

ORDERING INFORMATION	
Package	PowerPAK SO-8L
Lead (Pb)-free and halogen-free	SQJB46ELP (for detailed order number please see <u>www.vishay.com/doc?79771</u>)

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40	V	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current	T _C = 25 °C ^a	I	30		
	T _C = 125 °C	I _D	27		
Continuous source current (diode conduction) ^a		I _S	30	А	
Pulsed drain current ^b		I _{DM}	120		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	20.5		
Single pulse avalanche energy		E _{AS}	21	mJ	
Maximum power dissipation	T _C = 25 °C	PD	34	W	
	T _C = 125 °C	۳D	11		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak tempera		260			

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	LIMIT	UNIT	
Junction-to-ambient	PCB mount ^c	R _{thJA}	85	°C/W	
Junction-to-case (drain)		R _{thJC}	4.3	C/W	

Notes

a. Package limited

- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leaded package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection

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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static	•	•		•	•	•		
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		40	-	-	V	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		1.7	2.2	v	
Gate-source leakage	I _{GSS}	V _{DS} =	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	± 100	nA	
Zero gate voltage drain current		$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1	μA	
	I _{DSS}	$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 125 °C	-	-	50		
		$V_{GS} = 0 V$	V _{DS} = 40 V, T _J = 175 °C	-	-	250		
On-state drain current ^a	I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	25	-	-	А	
		$V_{GS} = 10 V$	I _D = 8 A	-	0.0064	0.0080		
D · · · · · · ·	Б	$V_{GS} = 10 \text{ V}$	I _D = 8 A, T _J = 125 °C	-	-	0.0131	Ω	
Drain-source on-state resistance ^a	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 8 A, T _J = 175 °C	-	-	0.0157		
		$V_{GS} = 4.5 V$	I _D = 5 A	-	0.0080	0.0100	1	
Forward transconductance b	g _{fs}	V _{DS} = 15 V, I _D = 8 A		-	46	-	S	
Dynamic ^b								
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	1499	2100	pF	
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	426	600		
Reverse transfer capacitance	C _{rss}			-	34	48		
Total gate charge ^c	Qg			-	26	40		
Gate-source charge ^c	Q _{gs}	$V_{GS} = 10 V$	$V_{GS} = 10 V$ $V_{DS} = 20 V$, $I_D = 3 A$		4.3	-	nC	
Gate-drain charge ^c	Q _{gd}			-	4.3	-		
Gate resistance	Rg	f = 1 MHz		1.26	2.54	3.8	Ω	
Turn-on delay time ^c	t _{d(on)}		V _{DD} = 20 V, R _I = 6.67 Ω		10	20	ns	
Rise time ^c	t _r				5	10		
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 3 \text{ A}, V_{\text{GEN}} = 10 \text{V}, \text{R}_\text{g} = 1 \Omega$		-	25	40		
Fall time ^c	t _f			-	6	12		
Source-Drain Diode Ratings and Chara	acteristics ^b							
Pulsed current ^a	I _{SM}			-	-	120	А	
Forward voltage	V _{SD}	I _F = 8 A, V _{GS} = 0 V		-	0.79	1.2	V	
Body diode reverse recovery time	t _{rr}	I _F = 6 A, di/dt = 100 A/μs		-	26	55	ns	
Body diode reverse recovery charge	Q _{rr}			-	15	33	nC	
Reverse recovery fall time	ta			-	13	-	-	
Reverse recovery rise time	t _b			-	13	-	ns	
Body diode peak reverse recovery current	I _{RM(REC)}			-	-0.97	-	А	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

2

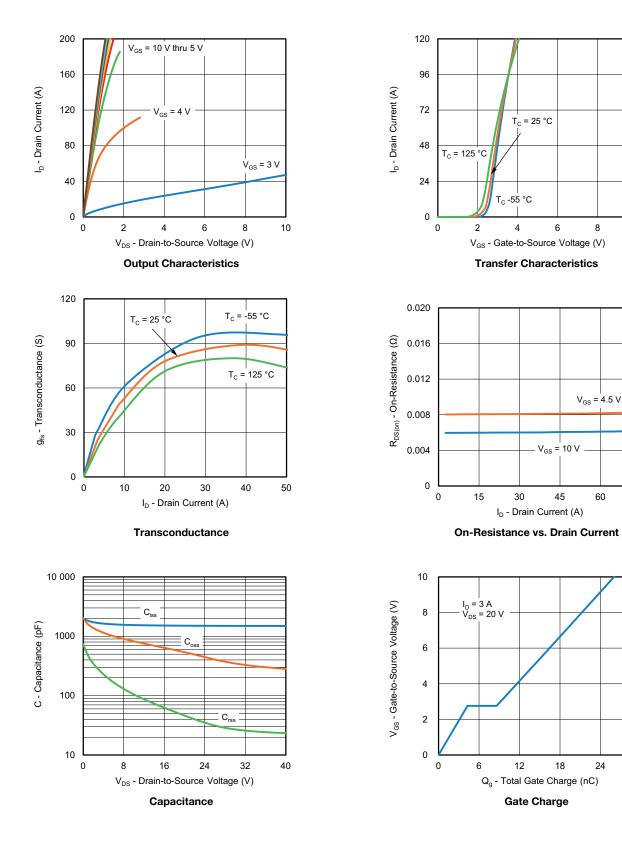


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TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



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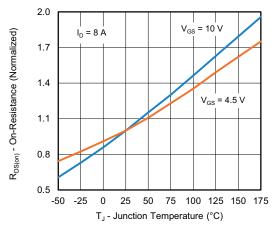
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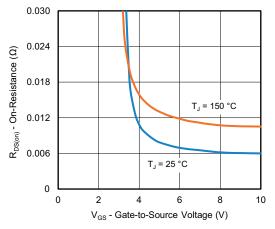
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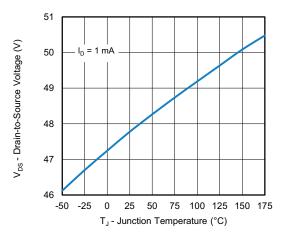
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



On-Resistance vs. Junction Temperature

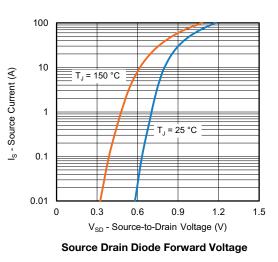


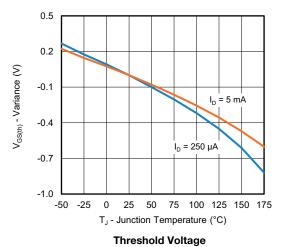
On-Resistance vs. Gate-to-Source Voltage

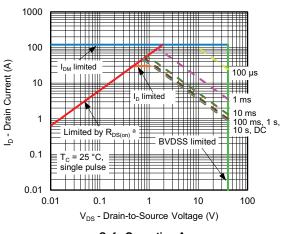


Drain Source Breakdown vs. Junction Temperature Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified







Safe Operating Area

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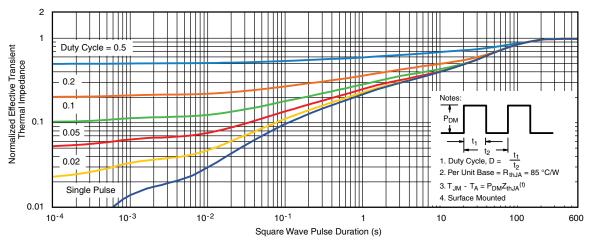
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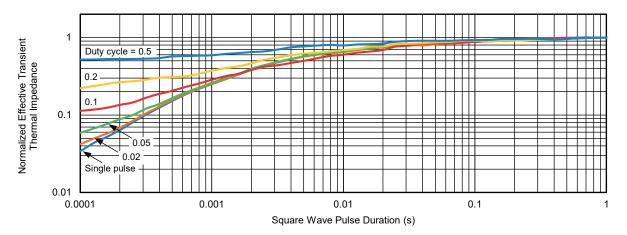


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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